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Electronic Patent Application Submission

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EFS ID: 59489
Application ID: 10026854
Title of Invention: ARTICLES FOR POLISHING
SEMICONDUCTOR SUBSTRATES
First Named Inventor: Shijian Li
Domestic/Foreign Application: Domestic Application
Filing Date: 2001-12-20
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Statement
Filing Type:
Confirmation number: 1816
Attorney Docket Number: AMAT/5765
Total Fees Authorized: 180.0
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Deposit Account Number: 200782
Deposit Account Name: Keith P Taboada
Access Code: ****
RAM Payment Status: RAM success
RAM User ID: EFSPROD
RAM Accounting Date: 2004-04-22
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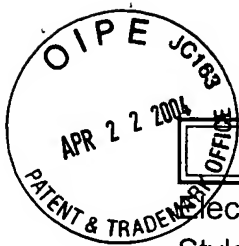
Digital Certificate Holder: cn=Keith Patrick Taboada,ou=Registered Attorneys,ou=Patent and
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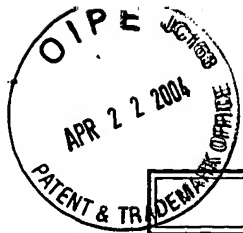
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Keith P Taboada Registered Number: 45150</td><td>/Keith P Taboada/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Keith P Taboada Registered Number: 45150	/Keith P Taboada/	Attorney								
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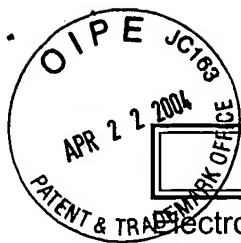
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Art Unit: 3723											
Examiner: Alvin JGrant											
TOTAL FEE AUTHORIZED \$180											
Patent fees are subject to annual revisions on or about October 1st of each year.											
BASIC FILING FEE											
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AUTHORIZED BILLING INFORMATION											
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Deposit account number: 200782											
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Deposit name: Moser Patterson and Sheridan LLP											
Deposit authorized name: Keith P Taboada											
Signature: /Keith P Taboada/											
Date (YYYYMMDD): 2004-04-22											



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ELECTRONIC INFORMATION DISCLOSURE STATEMENT

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Title of Invention	ARTICLES FOR POLISHING SEMICONDUCTOR SUBSTRATES																										
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